

# MG910M GaAs Hall Element

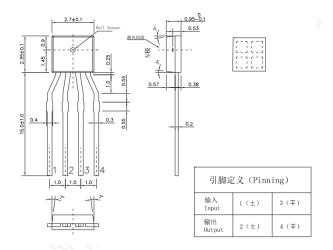
Linear GaAs Hall Element

**Excellent Thermal Characteristics** 

Thin-type SIP Package

Shipped in Bulk by Pack (500pcs devices per pack)

### Dimensional Drawing (Unit: mm)



### Absolute Maximum Rating

Operating Temperature Range Storage Temperature Range Maximum Input Current *I*<sub>cmax</sub> -40°C ~ 125°C -40°C ~ 150°C 15mA

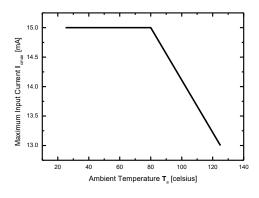


Figure 1. Maximum input current Icmax

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Electrical Characteristics (RT=25°C)

Item	Symbol	Test Condi.	Min.	Тур.	Max.	Unit
Hall Voltage	Ин	<b>B</b> = 50mT, <i>I</i> c=5mA <i>T</i> a = RT	36	45	54	mV
Input/Output Resist.	<b>R</b> in/out	<b>B</b> = 0mT, <b>I</b> <sub>C</sub> = 0.1mA <b>T</b> <sub>a</sub> = RT	650	750	850	Ω
Offset Voltage	Vos	<b>B</b> = 0mT, <b>I</b> <sub>C</sub> = 5mA <b>T</b> <sub>a</sub> = RT	-5		+5	mV
Temp. Coeffi. of $V_{H}$	α <b>/⁄</b> ⊦	<b>B</b> = 50mT, <b>I</b> <sub>C</sub> =5mA, <b>T</b> <sub>a</sub> = 25°C ~ 125°C	1		0.06	%/°C
Temp. Coeffi. of <b>R</b> n	α <b>R</b> in	$B = 0$ mT, $I_{C} = 0.1$ mA, $T_{a} = 25^{\circ}$ C ~ 125°C	N.	7	0.3	%/°C
Linearity of $V_{H}$	۵ <b>K</b>	<b>B</b> = 0.1 - 0.5T, <i>I</i> c =5mA <b>T</b> <sub>a</sub> = RT	-2		+2	%

Table 1. Electrical Characteristics of MG910M.

Note:

1. 
$$\boldsymbol{V}_{\mathrm{H}} = \boldsymbol{V}_{\mathrm{H}-\mathrm{M}} - \boldsymbol{V}_{\mathrm{os}}$$

In which  $V_{\text{H-M}}$  is the Output Hall Voltage,  $V_{\text{H}}$  is the Hall Voltage and  $V_{\text{os}}$  is the offset Voltage under

the identical electrical stimuli.

2. 
$$\alpha V_{\rm H} = \frac{1}{V_{\rm H}(T_{a1})} \times \frac{V_{\rm H}(T_{a2}) - V_{\rm H}(T_{a1})}{T_{a2} - T_{a1}} \times 100$$
  
 $T_{a1} = 25^{\circ}\text{C}, \quad T_{a2} = 125^{\circ}\text{C}$   
3.  $\alpha R_{\rm in} = \frac{1}{R_{\rm in}(T_{a1})} \times \frac{R_{\rm in}(T_{a2}) - R_{\rm in}(T_{a1})}{T_{a2} - T_{a1}} \times 100$   
 $T_{a1} = 25^{\circ}\text{C}, \quad T_{a2} = 125^{\circ}\text{C}$   
4.  $\Delta K = \frac{K(B_1) - K(B_2)}{\frac{K(B_1) + K(B_2)}{2}} \times 100 \quad K = \frac{V_{\rm H}}{I_c \times B}$   
 $B_1 = 0.5T, \quad B_2 = 0.1T$ 

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#### **Characteristic Curves**

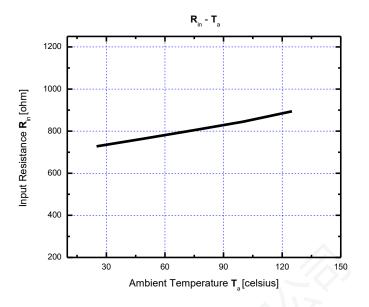


Figure 2. Input resistance  $R_{in}$  as a function of ambient temperature  $T_{a.}$ 

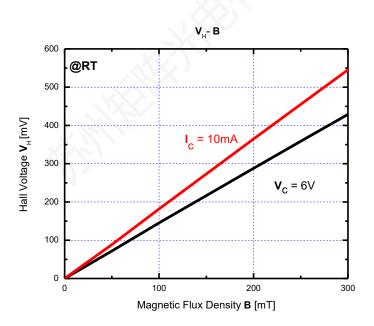


Figure 3. Hall voltage  $V_{\rm H}$  as a function of magnetic flux density **B**.

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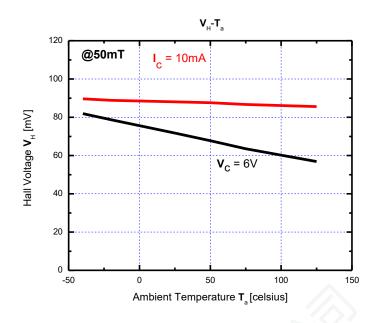


Figure 4. Hall voltage  $V_{\rm H}$  as a function of ambient temperature  $T_{\rm a}$ .

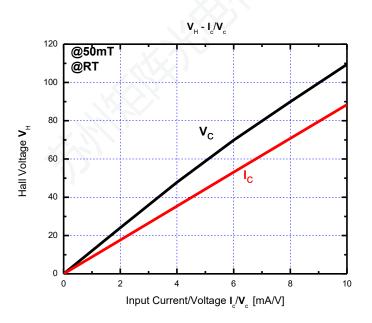


Figure 5. Hall voltage  $V_{\rm H}$  as a function of electrical stimuli  $I_{\rm c}/V_{\rm c}$ .

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## Matrix Opto. Co., Ltd -MG910M GaAs Hall Element-

**Reliability Test Terms** 

No.	Terms	Conditions	Duration
1	High Temperature Storage (HTS)	【JEITA EIAJ ED-4701】 <i>T</i> a =150(0 ~ +10)℃	1000 hrs
2	Heat Cycle (HC)	【JEITA EIAJ ED-4701】 <i>T</i> a=-55℃~150 ℃ high temp normal temp low temp. 30 min - 5 min - 30 min	50 cycles
3	Temp. Humidity Storage (THS)	【JEITA EIAJ ED-4701】 <i>Т<sub>а</sub></i> =85±3 °С, <i>R</i> <sub>H</sub> =85±5 %	1000 hrs
4	Resist. to Hand Soldering Heat (RHSH)	【JEITA EIAJ ED-4701】 Dipped in the 300±5 °C solder up to the 1 mm part from the body	5 sec
5	High Temp. Operating (HTO)	<b>7</b> a =125 °C, <b>V</b> c =7.5∨	1000 hrs

**Table 2.** Reliability Test Terms, Conditions and Duration.

Criteria:

- Variation of Hall Voltage  $V_{\rm H}$  and input/output resistances  $R_{\rm in/out}$  are less than 20%.

- Variation of offset voltage  $V_{os}$  is less than ±16mV.

- Other parameters in **Table 1**. are still within their ranges stated in **Table 1**.



### **Soldering Conditions**

The following conditions should be preserved. Solder ability should be checked by yourself, because it is

depend on solder paste material and other parameters.

Material of solder flux

- Use the resin based flux and refrain from using organic or inorganic acid based and water-soluble one.

Cleansing of solder flux conditions

- Use Ethanol or Isopropyl alcohol as cleansing material.
- Process temperature should be 50 °C or less.
- Duration should be 5 minutes or less.

Hand soldering conditions

- Apart from the mold resin more than 1mm.
- Solder at temperature 300 °C for less than 5s.

Wave soldering conditions

- Temperature in Pre-heating zone should be lower than 150°C.
- Temperature in Soldering zone should be lower than 280°C.



## Precautions for ESD

This product is the device that is sensitive to ESD (Electrostatic Discharge). Handling Hall Elements with

the ESD-Caution mark under the environment in which

- Static electrical charge is unlikely to arise (Ex: Relative Humidity over 40%RH).
- Wearing the anti-static suit and wristband when handling the devices.
- Implementing measures against ESD as for containers that directly touch the devices.

#### **Precautions for Storage**

- Products should be stored at an appropriate temperature and humidity (5°C to 35°C, 40%RH to

60%RH) after the unsealing of the MBB. Keeping products away from chlorine and corrosive gas.

- For storage longer than 2 years

Products are sealed in MBB with a desiccant. It is recommended to store in nitrogen atmosphere with

MBB sealed. Oxygen and H<sub>2</sub>O of atmosphere oxidizes leads of products and lead solder ability get

worse.

#### **Precautions for Safety**

- Do not alter the form of this product into a gas, powder or liquid through burning, crushing or chemical

processing.

- Observe laws and company regulations when discarding this product.